

JC20 Rec'd PCT/PTO 1 6 SEP 2005

APPLICATION DATA SHEET

Application Information	
Application Type::	Regular
Subject Matter::	Utility
Suggested Classification::	
Suggested Group Art Unit::	
CD-ROM or CD-R::	None
Title::	Copper Alloy Sputtering Target, Process for Producing the Same and Semiconductor Element Wiring
Attorney Docket Number::	OGOSH39USA
Request for Early Publication?	No
Request for Non-Publication?	No
Suggested Drawing Figure::	
Total Drawing Sheets::	None
Small Entity::	No
Petition Included::	No
Secrecy Order in Parent Application::	No

Applicant Information	
Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Takeo
Middle Name::	
Family Name::	Okabe
Name Suffix::	
City of Residence::	Ibaraki
State or Province of Residence::	
Country of Residence::	Japan
Street of Mailing Address::	c/o Isohara Factory of Nikko Materials Co., Ltd., 187-4, Usuba, Hanakawa-cho, Kitaibaraki-shi
City of Mailing Address::	Ibaraki
State or Province of Mailing Address::	
Country of Mailing Address::	Japan
Postal or Zip Code of Mailing Address::	319-1535

Correspondence Information	
Correspondence Customer Number::	00270
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Representative Information		
Representative Customer No. ::	00270	

Domestic Priority Information			
Application	Continuity Type	Parent Application	Parent Filing Date
This Application	National Stage of	PCT/JP2004/001914	02/19/04

Foreign Priority Information			
Country	Application Number	Filing Date	Priority Claimed
Japan	2003-071721	03/17/03	Yes

Assignee Information	
Assignee Name::	Nikko Materials Co., Ltd.
Street of Mailing Address::	10-1, Toranomom 2-chome, Minato-ku
City of Mailing Address::	Tokyo
State or Province of Mailing Address::	
Country of Mailing Address::	Japan
Postal or Zip Code of Mailing Address::	105-0001